

# Product Disposal Instructions

<b>Producer's Name :</b>	GUANGDONG OPPO MOBILE TELECOMMUNICATIONS CORP., LTD.
<b>Producer's Address :</b>	NO.18 HAIBIN ROAD, WUSHA VILLAGE, CHANG'AN TOWN, DONGGUAN CITY, GUANGDONG, CHINA

According to Directive 2012/19/EU, to assess the reuse, recycle and recovery, the product complied with the requirement of WEEE as follows:

## Product information

Product Model	OPD2503
Product Size	266.01mm×192.77mm×6.83mm
Category under the WEEE Directive	6 <sup>th</sup> category ( Small IT and telecommunications equipment )

## Selective Treatment for Materials and Components

According to Articles 8(2) and the Annex VII of the WEEE Directive, this product contains components and material items are described in the following table.

Component/Material	Size	Quantity	Weight (g)
Printed circuit boards of mobile phones generally, and of other devices if the surface of the printed circuit board is greater than 10 square centimeters	68.07cm <sup>2</sup>	1	25.1
Battery	/	1	147.1
liquid crystal displays (together with their casing where appropriate) of a surface greater than 100 square Centimeters and all those back-lighted with gas discharge lamps	501.6cm <sup>2</sup>	1	126.4

## Disassembly Procedure

The disassembly procedure taken here is in accordance with the treatment requirements under the Annex VII of the WEEE Directive. In addition, to consider economic and efficiency factors, manual operation and disassembly tools have been applied to separate the components and materials from this product in order to simulate the scenario at the treatment facility, and to achieve the objective that the separated components and materials can be reused, recycled and recovered.

## Disassembly Tool

The disassembly tools used for this product are heater, alcohol, tweezers, ejection pin, disassemble rod,

suction cup, screwdriver.

### Material and Recycling Information

The reuse, recycling and recovery assessment for this product is based upon economic and efficiency considerations, and the waste treatment technologies and equipment that are most frequently available to the market.

Component/Material Composition	Weight(g)	Percent Weight(%)	Reuse/Recycling Rate(%)	Energy Recovery Rate(%)	Recovery Rate(%)
Display part	126.2	28.16	18.31	0.28	18.59
Plastic part	83.0	18.52	15.00	1.85	18.86
Metal part	166.9	37.25	35.38	0.00	35.38
Heat dissipation film	3.4	0.76	0.67	0.04	0.71
Speaker with lens part	28.9	6.45	5.68	0.32	6.00
FPC unit	6.6	1.47	1.33	0.00	1.33
Card slot	0.4	0.09	0.08	0.00	0.08
PCB unit	25.1	5.60	5.04	0.00	5.04
PCB unit	4.2	0.94	0.84	0.00	0.84
Wire part	1.4	0.31	0.25	0.03	0.28
Screw part	1.7	0.38	0.36	0.00	0.36
Total	447.8	99.93	82.94	2.53	85.47

Name, Surname : Jerry, lao

Position/Title : Compliance Manager

2025.12.15

(Date)

(legal signature)



